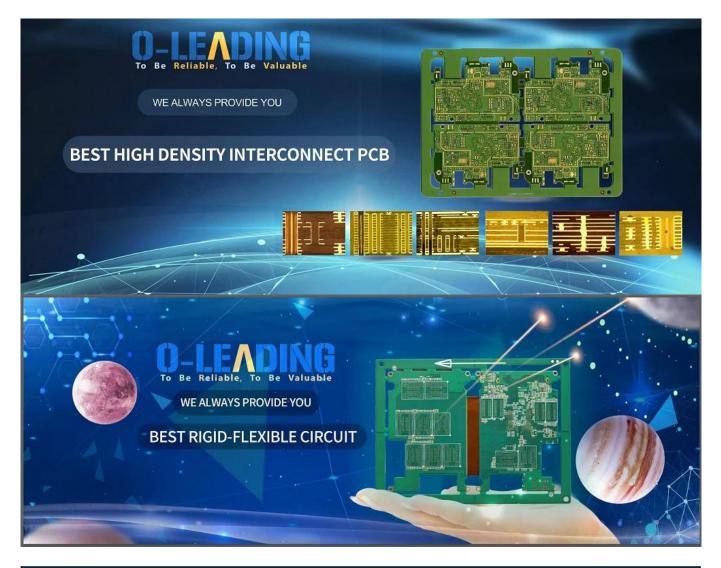
Welcome to O-leading

O-Leading strives to be your one stop solution partner **Printed circuit boards supplier** in EMS supply chain, including PCB design, PCB fabrication and PCB assembly (PCBA),We provide some of the most advanced PCB technology, including HDI PCBs,multilayer PCBs, Rigid-Flexible PCBs.We can support from quick turn prototype to medium & mass Production.

In general, our global customers are very impressed with our services:Rapid response, competitive price and quality commitment.Providing more valuable technical service and overall solution is the way Oleading forward.

Looking to the future, O-leading will concentrate on the innovation and development of electronics manufacturing technology as always, and make persistent efforts on PCB & PCBA one-stop service to provide first-class services and create more value for our customers.

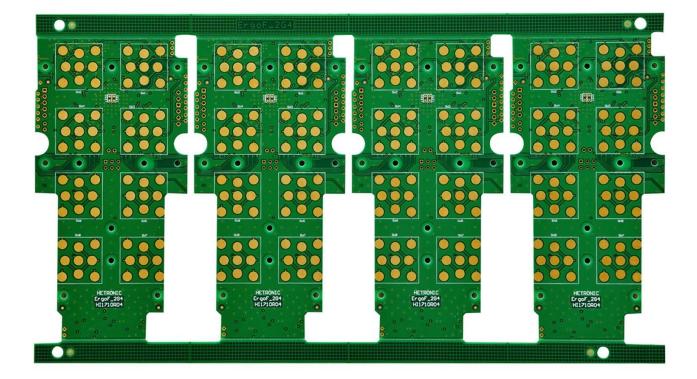
PLEASE CLICK THESE FOR MORE INFORMATION <u>OEM manufacture Multilayer+PCB Board Printed</u> <u>Circuit Boards PCB fabrication</u>



Product Description

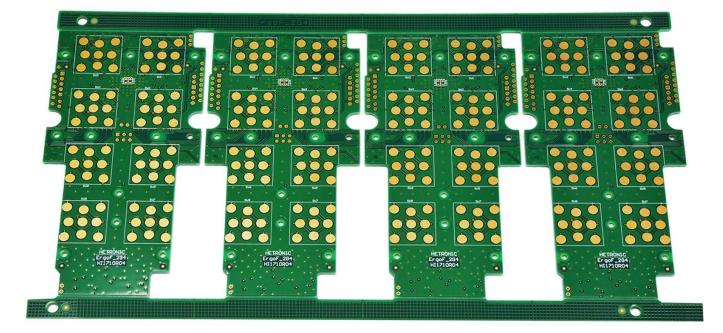






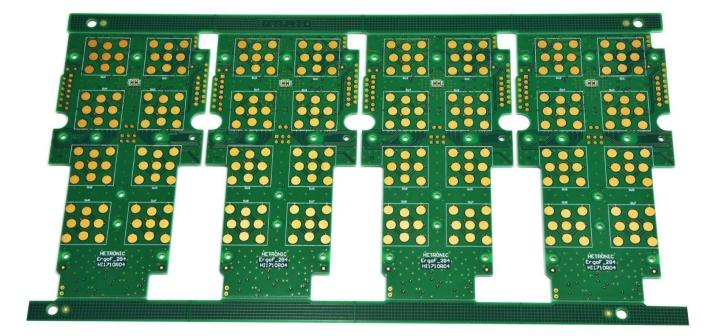






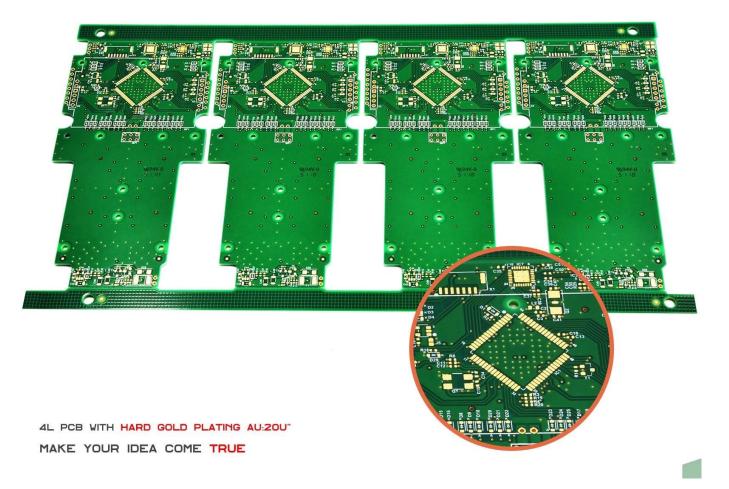






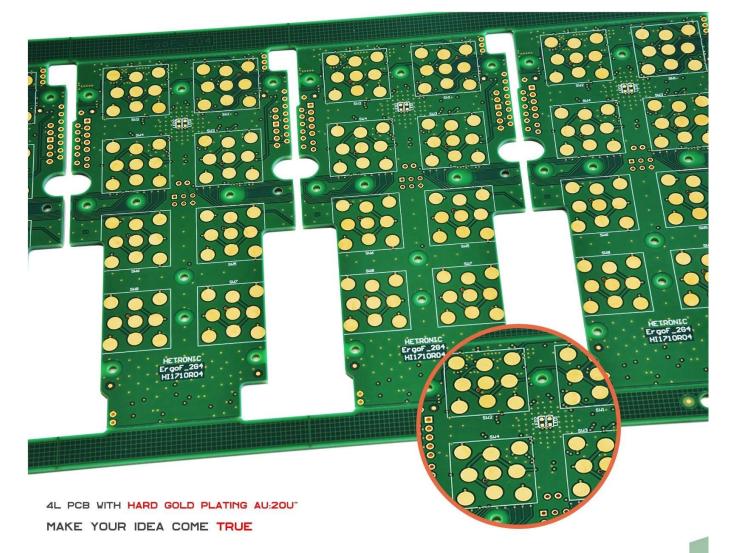






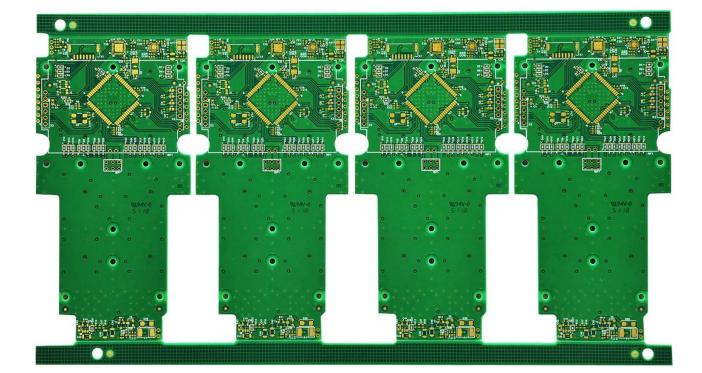




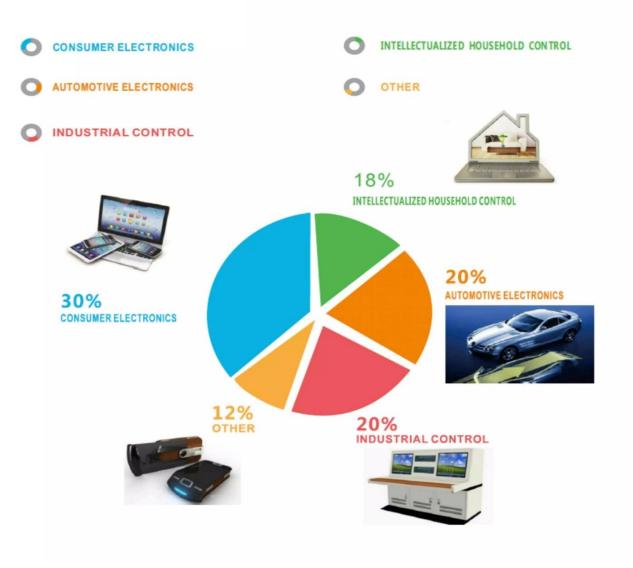


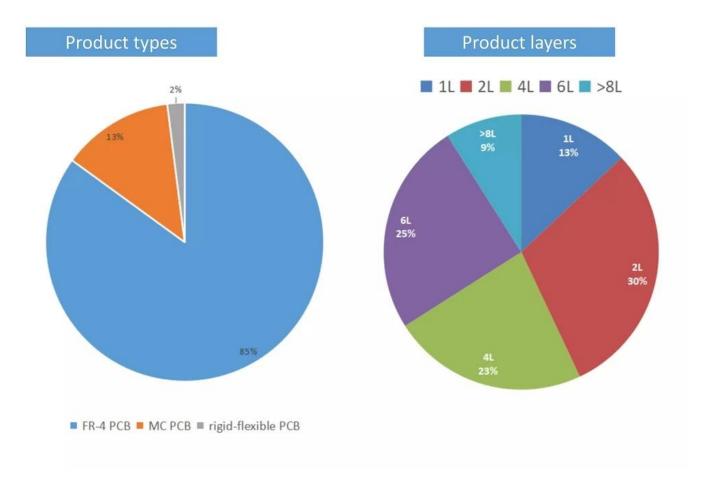






Market Share





Production Process

18 years experience in one-stop PCB and PCBA, we can make your idea come true,



Our Team



Factory PCB





Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

- Factory SMT













To be **AELIABLE**

Quality first ,

Customer supreme ,

Scientifically management ,

Striving for famous brand







To be **Valuaale**

Science and technology keeps head ,

Put people first,

Be precise and practical,

contribute sincerely



合作伙伴 Customers

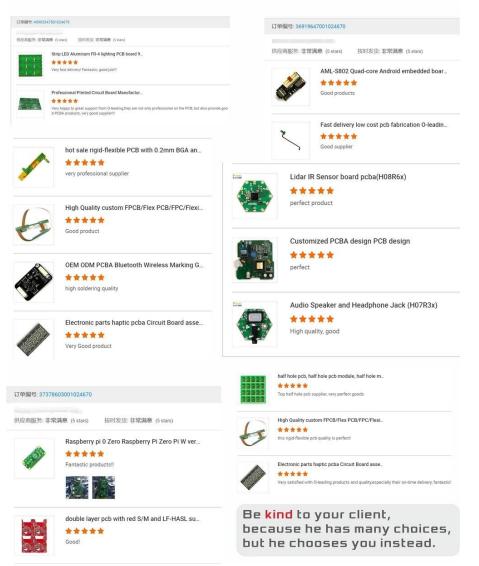


O-LEADING *CUSTOMER REVIEW*

CUSTOMER VOICE IS EXTREMELY IMPORTANT TO US

订单编号: 49335	5463501024670	订伸编号: 45922411001024670
供应商服务: 非常		605時后分: 世際調練 (Sister) 裕田(25): 世際編集 (Sister) High TG180 FR4 Circuit HOJ PCB 94V0 Board
	High quality usb power pcb , pcba manufacturer	High Tu Lie In HeAL CREATE HILD PLAN YOU BOND High Tu Lie In HeAL CREATE HILD PLAN YOU BOND High Tu Lie In HeAL CREATE HILD PLAN YOU BOND High Tu Lie In HeAL CREATE HILD PLAN YOU BOND HIGH TU LIE HEAL CREATE HILD PLAN YOU BOND
	Fancy has done an exilent job, whenever we write, she answered us within 1 second, O-leading is very perfe cr with fast delivery, fast logistics, the most important thing is good quality, good packaging, thank you!	universal TR4 Multilayer PCB washing machine
	oem customized tohs pcb drawing schematic s ******* We received the boards, the quality is very good the price is very reasonable. Fancy is very nice & smart & e sperimend, the digitatic is super Fall vill come to see more in the future.	57件編号: 49024962001024070
订单编号: 49298;	同意演评论	High quality Keyboard pcb & pcba Factory SMT
巴皮商服务: 非常		Electric contraction of the second se
<i>M</i> ,	High TG180 FR-4 Circuit HDI PCB 94V0 Board	门用展号-409842250102473 POIRESE 年1528日 (2 Sone) HIFESE 年1528日 (2 Sone) Polessonal Primed Circuit Board Manufactur
ananananan ananananan ananananan ananananan ananananan tararananan	eem customized rohs pcb drawing schematic s	***** Vry high builty PCB products. Orkeding is the best PCB sugginise that we have ever worked with UTGPR-0F: LICKASTP26501026210
	國國議評论	(供应商服务: 非常满意 (5 stars) 按时发货: 非常满意 (5 stars)
	Strip LED Aluminum FR-4 lighting PCB board 9 ******* High quality, fast delivery, good service, competitive price, lucky and happy to purchase from O-leading!	High TGI80 FR4 Circuit HDI PCB 94V0 Board

LISTER TO CUSTOMER VOICE



Certifications





O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

Test Report

SGS

Test Report

No. SZXEC1900530401

Date: 30 Mar 2019 Page 2 of 6

Test Part Description :

Test Results :

Specimen No. SGS Sample ID Description SN1 SZX19-005304.001 Green"PCB"

Date: 30 Mar 2019 Page 1 of 6

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

No. SZXEC1900530401

SGS Job No. :	RP19-005089 - SZ
Date of Sample Received :	22 Mar 2019
Testing Period :	22 Mar 2019 - 30 Mar 2019
Test Requested :	Selected test(s) as requested by client.
Test Method :	Please refer to next page(s).
Test Results :	Please refer to next page(s).
Conclusion :	Based on the performed tests on submitted sample(s), the results of Lead, Marcury, Cadmium, Horavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Big2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dbutyl phthalate (DBP), and Disobutyl phthalate (DBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/85/EU.

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

Signed for and on behalf of SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina

Tina Fan Approved Signatory



Member of the SGS Group (SGS SA)

Remarks : (1) 1 mg/kg = 1 ppm = 0.0001%
 (2) MDL = Method Detection Limit (3) ND = Not Detected (< MDL)

(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/85/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7:2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s)	Limit	Unit	MDL	001
Cadmium (Cd)	100	mg/kg	2	ND
_ead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1.000	mg/kg		ND
Monobromobiphenyl		mg/kg	5	ND
Dibromobiphenyl	12	mg/kg	5	ND
Tribromobiphenyl		mg/kg	5	ND
Tetrabromobiphenyl		mg/kg	5	ND
Pentabromobiphenyl		mg/kg	5	ND
Hexabromobiphenyl		mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl		mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl		mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg		ND
Monobromodiphenyl ether		mg/kg	5	ND
Dibromodiphen yl ether		mg/kg	5	ND
Tribromodiphenyl ether		mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND



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UL Product iQ™



E490354

ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

ROOM 1205, 12/F TAI SANG BANK BLDG 130-132 DES VOEUS ROAD CENTRAL, HONG KONG

	Cond	Width			Max			Max			
		Min	Cond	SS/	Area	Solo	der	Oper		Meets	с
	Min	Edge	Thk	DS/	Diam	Lim	its	Temp	Flame	UL796	т
Туре	mm(in)	mm(in)	mic(mil)	DSO	mm(in)	с	sec	с	Class	DSR	L
Multilayer (m	ass laminate) p	rinted wiring l	ooards.								
O-LEADING- 401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING- 407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer pri	nted wiring bo	ards.	A								
O-LEADING- 408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer p	rinted wiring b	oards.	n.					600	3 7	200	
O-LEADING- 002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING- 003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0		-
O-LEADING- 033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING- 205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING- 206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING- D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING- S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING- S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	НВ		*
O-LEADING- S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Process Capability

PCB Production Capabilities					
Layer Count	1Layer-32Layer				
Finished copper thickness	1/3oz-12oz				
Min Line width/spacing internal	3.0mil/3.0mil				
Min Line width/spacing external	4.0mil/4.0mil				
Max Aspect Ratio	10:1				
Board thickness	0.2mm-5.0mm				
Max Panel size(inches)	635*1500mm				
Minimum Drilled Hole Size	4mil				
Plated Hole Tolerance	+/-3mil				
Blind/Buried Vias (AII Types)	YES				
Via Fill(Conductive,Non-Conductive)	YES				
Base Material	FR-4,FR-4high Tg.Halogen fr	ree material,Rogers,Aluminium base,Polyimide,Heavy Copper			
Surface finishes	HASL,OSP,ENIG,HAL-LF,lm	mersion silver, Immersion Tin, Gold fingers, Carbon ink			
SMT Production Capabi	ilities				
PCB Material		FR-4,CEM-1,CEM-3,Aluminum-based board,FPC			
Max PCB size		510x1500mm			
Min PCB size		50x50mm			
PCB Thickness		0.5mm-4.5mm			
Board thickness		0.5-4mm			
Min Components size		0201			
Standard chip size component		0603 and larger			
Component max height		15mm			
Min lead pitch		0.3mm			
Min BGA ball pitch		0.4mm			
Placement precision		+/-0.03mm			

Packaging & Delivery

Shipping service





Express

Quick Turn Lead Time					
Layer Count:	Lead Tim	Special Requirement			
1L/2L	2-3days	24 Hours,48 Hours			
4L	3-4days	48 Hours			
6L	4-5days	72 Hours			
8L	5-6days	NA			
10L	6-7days	NA			
12L	7-8days	NA			
14L	8-9days	NA			

Standard Lead Time					
Layer Count:	Sample Lead Time	Volume order lead time			
2L	4 days	10 days			
4L	5 days	11 days			
6L	6 days	12 days			
8L	8 days	14 days			
10L	10 days	16 days			
12L	12 days	18 days			
14L	14 days	20 days			
16-32L	18 days	24 days			

FAQ

1. How do O-Leading ensure quality?Our high quality standard is achieved with the following.

1.1 The process is strictly controlled under ISO 9001:2008 standards.

1.2 Extensive use of software in managing the production process

1.3 State-of-art testing equipments and tools. E.g. Flying Probe, X-ray Inspection, AOI (Automated Optical Inspector) and ICT(in-circuit testing).

1.4.Dedicated quality assurance team with failure case analysis process

1.5.Continuous staff training and education

2. How do O-Leading keep your price competitive?

Over the last decade, prices of many raw materials (e.g. copper, chemicals) had doubled, tripled or quadrupled; Chinese currency RMB had appreciated 31% over US dollar; And our labor cost also increased significantly.

However, O-Leading have kept our pricing steady. This owns entirely to our innovations in reducing cost, avoiding wastes and improving efficiency. Our prices are very competitive in the industry at the same quality level.

We believe in a win-win partnership with our customers. Our partnership will be mutually beneficial if we can provide you anedgeon cost and quality.

3. What kinds of boards can O-Leading process?

Common FR4, high-TG and halogen-free boards, Rogers, Arlon, Telfon, aluminum/copper-based boards, PI, etc.

4. What data are needed for PCB & PCBA production?

4.1 BOM (Bill of Materials) with reference designators: component description, manufacturer's name and part number.

4.2 PCB Gerber files.

4.3 PCB fabrication drawing and PCBA assembly drawing.

4.4 Test procedures.

4.5 Any mechanical restrictions such as assembly height requirements.

5. What's the typical process flow for multi-layer PCB?

Material cutting \rightarrow Inner dry film \rightarrow inner etching \rightarrow Inner AOI \rightarrow Multi-bond \rightarrow Layer stack up Pressing \rightarrow Drilling \rightarrow PTH \rightarrow Panel Plating \rightarrow Outer Dry Film \rightarrow Pattern Plating \rightarrow Outer etching \rightarrow Outer AOI \rightarrow Solder Mask \rightarrow Component Mark \rightarrow Surface finish \rightarrow Routing \rightarrow E/T \rightarrow Visual Inspection.

6. What's the key equipments for HDI manufacturing?

Key equipment list is as following: Laser drilling machine, Pressing machine, VCP line, Automatic Exposing machine, LDI and etc. The equipments we have are the best in the industry, laser drilling machines are from Mitsubishi and Hitachi, LDI machines are from Screen(Japan), Automatic Exposing machines are also from Hitachi, all of them make we can meet customer's technical requirements.

7. How many types of surface finish O-lead can do?

O-the leader has the full series of surface finish, such as: ENIG, OSP, LF-HASL, gold plating (soft/hard), immersion silver, Tin, silver plating, immersion tin plating, carbon ink and etc. .. OSP, ENIG, OSP + ENIG commonly used on the HDI, we usually recommend that you use a client or OSP OSP + ENIG if BGA PAD size less than 0.3 mm.

8. What's your capability for FPC? Can O-Leading provide SMT service also?

O-Leading can fabricate FPC from single layer to 8layer, the working panel size can be as large as 2000mm*240mm, please find the details in the page "Flex Capability". We also provide SMT one stop service to customer.

9. What are the main factors which will affect the price of PCB?

Material; Surface finish; Technology difficulty; Different quality criteria; PCB characteristics; Payment terms; Different manufacturing countries.

10. What's the definition of PCB, PWB and FPC and what's the difference?

PCB is short for Printed Circuit Board; PWB is short for Printed Wire Board, same meaning as Printed Circuit Board; FPC is short for Flexible Printed Board.

11. What factors should be considered when choosing the material for a PCB board?

Below factors should be considered when we choose the material for PCB: The material's Tg value should be greater than the operation temperature; Low CTE material has good performance of thermal stability; Good thermal resistance performance: Normally PCBs are required to resist 250°C for at least 50s. Good flatness; In consideration of the electrical properties, low loss/high permittivity material is used on high frequency PCB;

Polyimide glass fiber substrate used for flexible PCB; Metal core is used when the product has strict requirement of heat dissipation.

12. What's the merits of O-leading's rlgid-flex PCB?

O-leading's rigid-flex PCB has the characters of both FPC and PCB, so it can be used in some special products. Some part is flexible while the other part rigid, it can help save product's interior space, reduce product volume and improve performance.

13. How to you make the impedance calculation?

The impedance control system is done using some test coupons, the SI6000 soft and the CITS 500s equipment from POLAR INSTRUMENTS. The equipment measures the impedance on a representative track configuration coupon of which the client has given us a determinate value and tolerance.